



# DATA SHEET

## B1S~B10S

### MINI SURFACE MOUNT GLASS PASSIVATED BRIDGE RECTIFIER

**VOLTAGE - 100 to 1000 Volts CURRENT - 0.5 Amperes**

#### FEATURES

- Plastic material used carries Underwriters
- Laboratory recognition 94V-O
- Low leakage
- Surge overload rating-- 30 amperes peak
- Ideal for printed circuit board
- Exceeds environmental standards of MIL-S-19500

#### MECHANICAL DATA

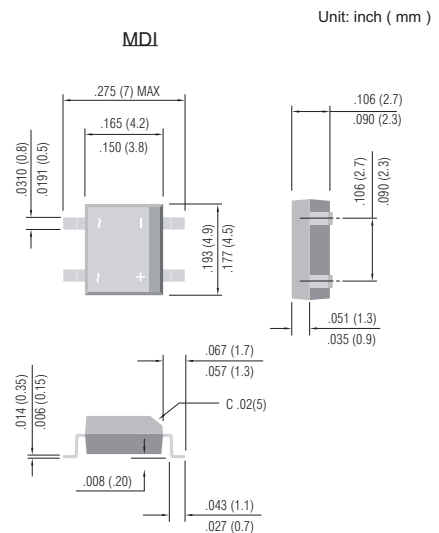
Case: Reliable low cost construction utilizing molded plastic technique results in inexpensive product

Terminals: Lead solderable per MIL-STD-202, Method 208.

Polarity: Polarity symbols molded or marking on body.

Mounting Position: Any.

Weight: 0.008 ounce, 0.22 gram.



#### MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified.

Single phase, half wave, 60Hz, Resistive or inductive load.

For capacitive load, derate current by 20%

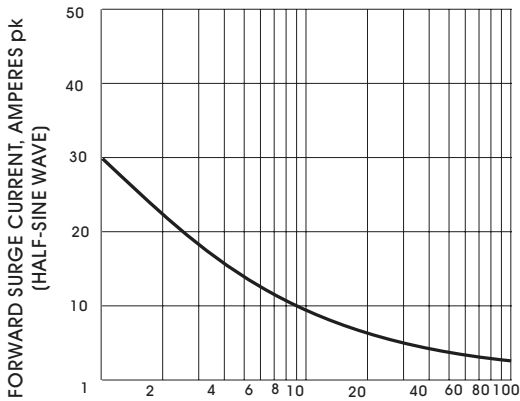
	B1S	B2S	B4S	B6S	B8S	B10S	UNIT
Maximum Recurrent Peak Reverse Voltage	100	200	400	600	800	1000	V
Maximum RMS Bridge input Voltage	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	100	200	400	600	800	1000	V
Maximum Average Forward Current $T_A=30^\circ\text{C}$ on glass-epoxy P.C.B (Note 1) on aluminum substrate (Note 3)	0.5 0.8						A
Peak Forward Surge Current, 8.3ms single half sine-wave superimposed on rated load	30.0						A
$I^2t$ Rating for fusing ( $t < 8.35$ ms)	5.0						$\text{A}^2\text{t}$
Maximum Forward Voltage Drop per Bridge Element at 0.5A	1.00						V
Maximum Reverse Current at Rated $T_J= 25^\circ\text{C}$ DC Blocking Voltage per element $T_J=125^\circ\text{C}$	5.0						$\mu\text{A}$ mA
Typical Junction capacitance per leg (Note 1) CJ	25.0						pF
Typical Thermal resistance per leg (Note 2) $R\theta\text{JA}$ Typical Thermal resistance per leg (Note 2) $R\theta\text{JA}$	85.0						$^\circ\text{C}/\text{W}$
Operating Temperature Range $T_J$	-55 to 150						$^\circ\text{C}$
Storage Temperature Range $T_A$	-55 to 150						$^\circ\text{C}$

**NOTES:**

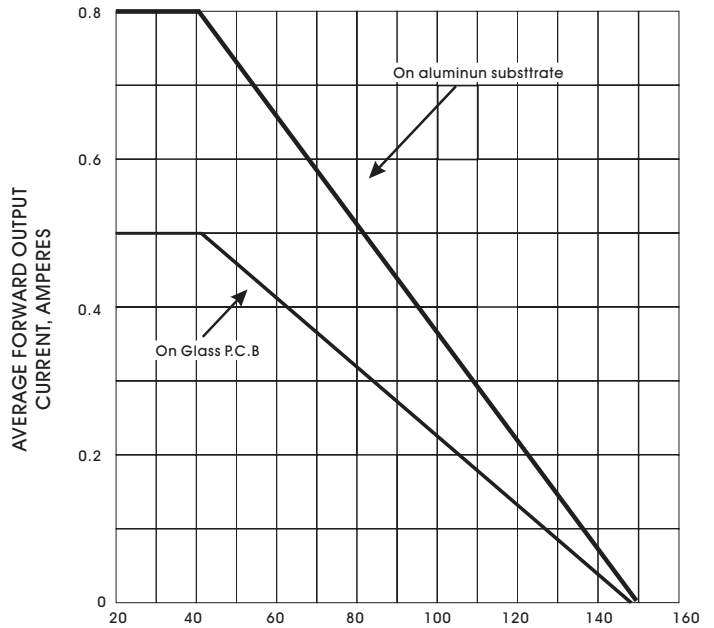
1. Measured at 1.0 MHz and applied reverse voltage of 4.0 Volts
2. Thermal resistance from junction to ambient and from junction to lead mounted on P.C.B. with 0.05 X 0.05" (13 x 13mm) copper pads.
3. On alum: substrate P.C.B with an area of 0.8 x 0.8 x 0.25" ( 20 x 20 x 6.4mm ) mounted on 0.05 x 0.05 " ( 13 x 13 mm ) solder pad.



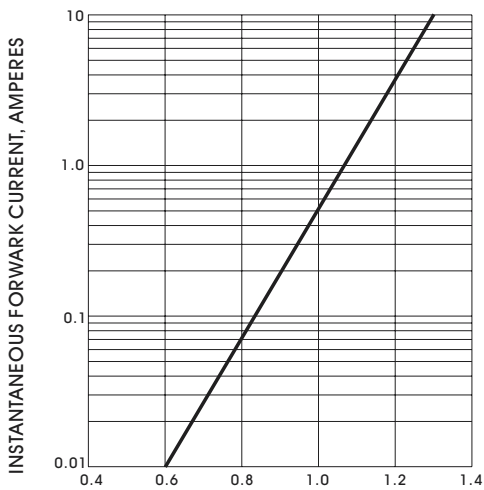
**RATING AND CHARACTERISTIC CURVES**



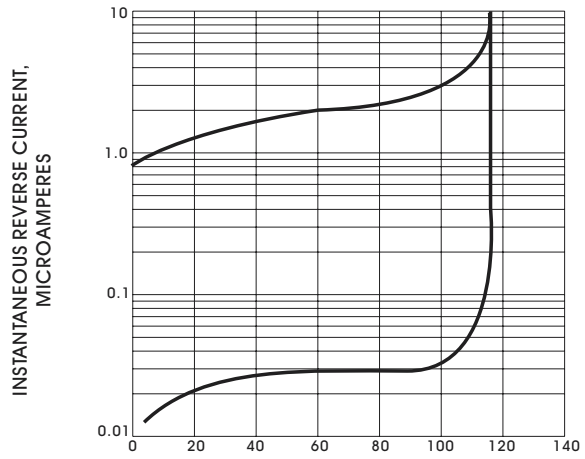
NUMBER OF CYCLES AT 60Hz  
**Fig.1-MAXIMUM NON-REPETITIVE SURGE CURRENT**



AMBIENT TEMPERATURE, °C  
**Fig.2-DERATING CURVE FOR OUTPUT RECTIFIED CURRENT**



INSTANTANEOUS FORWARD VOLTAGE, VOLTS  
**Fig.3-TYPICAL FORWARD CHARACTERISTICS**



PERCENT OF PEAK REVERSE VOLTAGE  
**Fig.4-TYPICAL REVERSE CHARACTERISTICS**